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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	XCore
Core Size	32-Bit 16-Core
Speed	2000MIPS
Connectivity	USB
Peripherals	-
Number of I/O	104
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	236-LFBGA
Supplier Device Package	236-FBGA (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xu216-512-fb236-i20

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2 XU216-512-FB236 Features

► Multicore Microcontroller with Advanced Multi-Core RISC Architecture

- 16 real-time logical cores on 2 xCORE tiles
- Cores share up to 1000 MIPS
 - Up to 2000 MIPS in dual issue mode
- Each logical core has:
 - Guaranteed throughput of between $\frac{1}{5}$ and $\frac{1}{8}$ of tile MIPS
 - 16x32bit dedicated registers
- 167 high-density 16/32-bit instructions
 - All have single clock-cycle execution (except for divide)
 - 32x32→64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions

► USB PHY, fully compliant with USB 2.0 specification

► Programmable I/O

- 128 general-purpose I/O pins, configurable as input or output
 - Up to 32 x 1bit port, 12 x 4bit port, 8 x 8bit port, 4 x 16bit port, 2 x 32bit port
 - 8 xCONNECT links
- Port sampling rates of up to 60 MHz with respect to an external clock
- 64 channel ends (32 per tile) for communication with other cores, on or off-chip

► Memory

- 512KB internal single-cycle SRAM (max 256KB per tile) for code and data storage
- 16KB internal OTP (max 8KB per tile) for application boot code

► Hardware resources

- 12 clock blocks (6 per tile)
- 20 timers (10 per tile)
- 8 locks (4 per tile)

► JTAG Module for On-Chip Debug

► Security Features

- Programming lock disables debug and prevents read-back of memory contents
- AES bootloader ensures secrecy of IP held on external flash memory

► Ambient Temperature Range

- Commercial qualification: 0°C to 70°C
- Industrial qualification: -40°C to 85°C

► Speed Grade

- 20: 1000 MIPS

► Power Consumption

- 570 mA (typical)

► 236-pin FBGA package 0.5 mm pitch

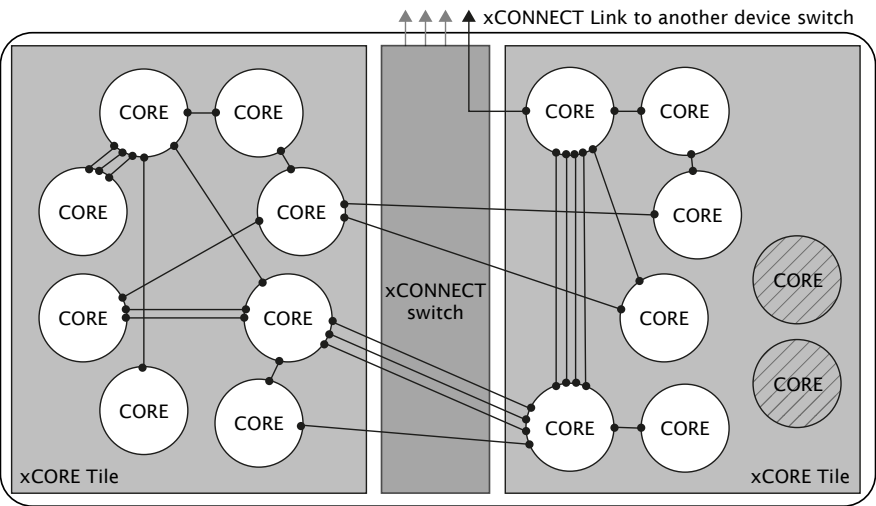


Figure 6:
Switch, links
and channel
ends

and packet switched data can both be supported efficiently. Streams provide the fastest possible data rates between xCORE Tiles (up to 250 MBit/s), but each stream requires a single link to be reserved between switches on two tiles. All packet communications can be multiplexed onto a single link.

Information on the supported routing topologies that can be used to connect multiple devices together can be found in the XS1-U Link Performance and Design Guide, [X2999](#).

7 PLL

The PLL creates a high-speed clock that is used for the switch, tile, and reference clock. The PLL multiplication value is selected through the two MODE pins, and can be changed by software to speed up the tile or use less power. The MODE pins are set as shown in Figure 7:

Oscillator Frequency	MODE		Tile Boot Frequency	PLL Ratio	PLL settings		
	1	0			OD	F	R
3.25-10 MHz	0	0	130-400 MHz	40	1	159	0
9-25 MHz	1	1	144-400 MHz	16	1	63	0
25-50 MHz	1	0	167-400 MHz	8	1	31	0
50-100 MHz	0	1	196-400 MHz	4	1	15	0

Figure 7:
PLL multiplier
values and
MODE pins

Feature	Bit	Description
Disable JTAG	0	The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
Disable Link access	1	Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a “secure island” with other tiles free for non-secure user application code.
Secure Boot	5	The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (<i>see §8</i>).
Redundant rows	7	Enables redundant rows in OTP.
Sector Lock 0	8	Disable programming of OTP sector 0.
Sector Lock 1	9	Disable programming of OTP sector 1.
Sector Lock 2	10	Disable programming of OTP sector 2.
Sector Lock 3	11	Disable programming of OTP sector 3.
OTP Master Lock	12	Disable OTP programming completely: disables updates to all sectors and security register.
Disable JTAG-OTP	13	Disable all (read & write) access from the JTAG interface to this OTP.
Disable Global Debug	14	Disables access to the DEBUG_N pin.
	21..15	General purpose software accessible security register available to end-users.
	31..22	General purpose user programmable JTAG UserID code extension.

Figure 13:
Security
register
features

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through `libotp` and `xburn`.

9.2 SRAM

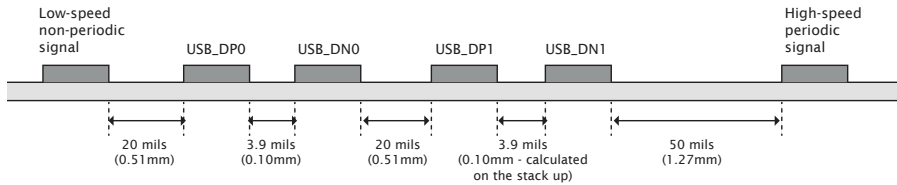
Each xCORE Tile integrates a single 256KBSRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

10 USB PHY

The USB PHY provides High-Speed and Full-Speed, device, host, and on-the-go functionality. The PHY is configured through a set of peripheral registers (Appendix F),

Figure 19:

USB trace separation showing a low speed signal, two differential pairs and a high-speed clock



12.2.1 General routing and placement guidelines

The following guidelines will help to avoid signal quality and EMI problems on high speed USB designs. They relate to a four-layer (Signal, GND, Power, Signal) PCB.

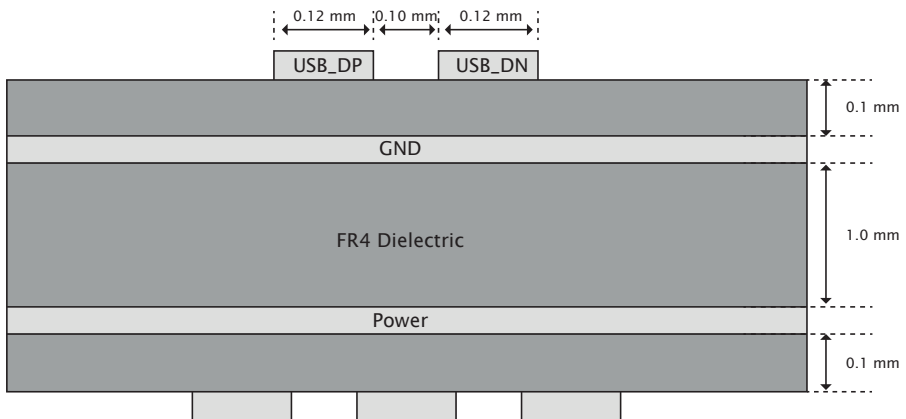


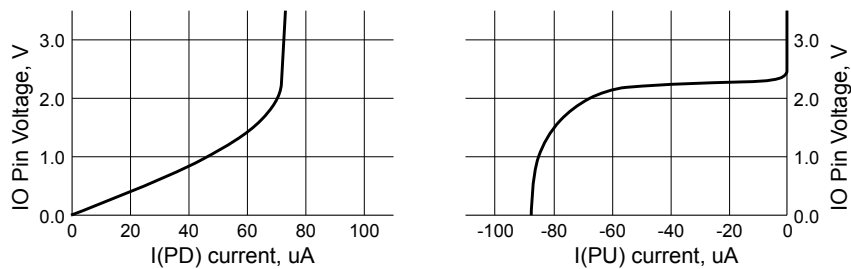
Figure 20:
Example USB
board stack

For best results, most of the routing should be done on the top layer (assuming the USB connector and XS2-U16A-512-FB236 are on the top layer) closest to GND. Reference planes should be below the transmission lines in order to maintain control of the trace impedance.

We recommend that the high-speed clock and high-speed USB differential pairs are routed first before any other routing. When routing high speed USB signals, the following guidelines should be followed:

- ▶ High speed differential pairs should be routed together.
- ▶ High-speed USB signal pair traces should be trace-length matched. Maximum trace-length mismatch should be no greater than 4mm.
- ▶ Ensure that high speed signals (clocks, USB differential pairs) are routed as far away from off-board connectors as possible.

Figure 23:
Typical
internal
pull-down
and pull-up
currents



13.3 ESD Stress Voltage

Figure 24:
ESD stress
voltage

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
HBM	Human body model	-2.00		2.00	KV	
CDM	Charged Device Model	-500		500	V	

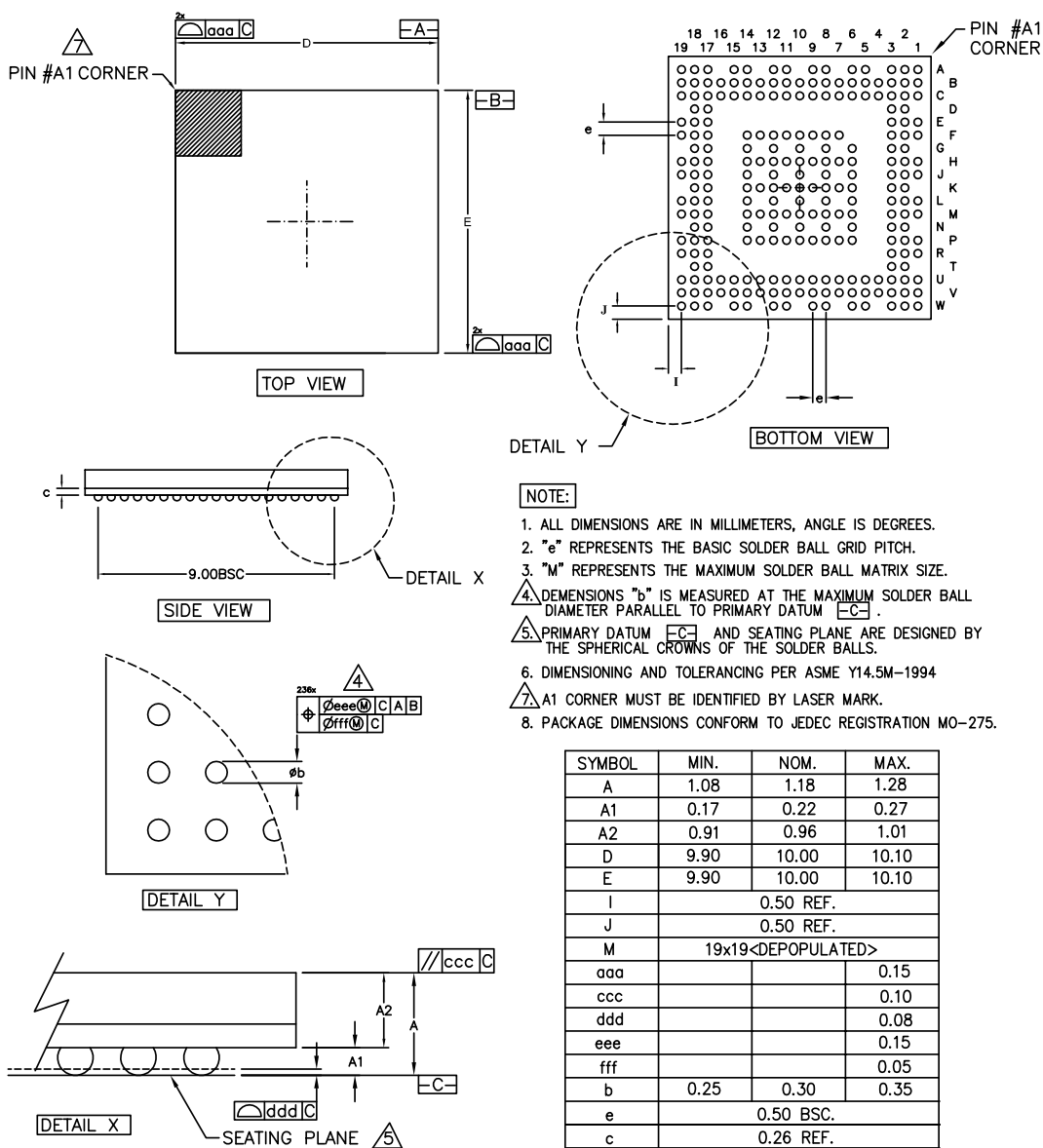
13.4 Reset Timing

Figure 25:
Reset timing

Symbol	Parameters	MIN	TYP	MAX	UNITS	Notes
T(RST)	Reset pulse width	5			μs	
T(INIT)	Initialization time			150	μs	A

A Shows the time taken to start booting after RST_N has gone high.

14 Package Information



Appendices

A Configuration of the XU216-512-FB236

The device is configured through banks of registers, as shown in Figure 33.

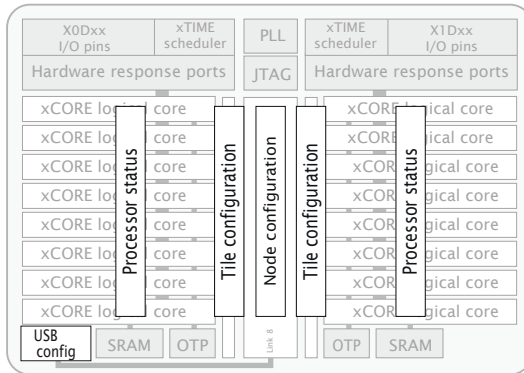


Figure 33:
Registers

The following communication sequences specify how to access those registers. Any messages transmitted contain the most significant 24 bits of the channel-end to which a response is to be sent. This comprises the node-identifier and the channel number within the node. If no response is required on a write operation, supply 24-bits with the last 8-bits set, which suppresses the reply message. Any multi-byte data is sent most significant byte first.

A.1 Accessing a processor status register

The processor status registers are accessed directly from the processor instruction set. The instructions GETPS and SETPS read and write a word. The register number should be translated into a processor-status resource identifier by shifting the register number left 8 places, and ORing it with 0x0B. Alternatively, the functions `getps(reg)` and `setps(reg,value)` can be used from XC.

A.2 Accessing an xCORE Tile configuration register

xCORE Tile configuration registers can be accessed through the interconnect using the functions `write_tile_config_reg(tileref, ...)` and `read_tile_config_reg(tile ↪ ref, ...)`, where `tileref` is the name of the xCORE Tile, e.g. `tile[1]`. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the xCORE tile configuration registers. The destination of the channel-end should be set to `0xnnnnC20C` where `nnnnn` is the tile-identifier.

A write message comprises the following:

control-token 192	24-bit response channel-end identifier	16-bit register number	32-bit data	control-token 1
----------------------	---	---------------------------	----------------	--------------------

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

control-token 193	24-bit response channel-end identifier	16-bit register number	control-token 1
----------------------	---	---------------------------	--------------------

The response to the read message comprises either control token 3, 32-bit of data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).

A.3 Accessing node configuration

Node configuration registers can be accessed through the interconnect using the functions `write_node_config_reg(device, ...)` and `read_node_config_reg(device, ↵ ...)`, where `device` is the name of the node. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the node configuration registers. The destination of the channel-end should be set to `0xnnnnC30C` where `nnnn` is the node-identifier.

A write message comprises the following:

control-token 192	24-bit response channel-end identifier	16-bit register number	32-bit data	control-token 1
----------------------	---	---------------------------	----------------	--------------------

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

control-token 193	24-bit response channel-end identifier	16-bit register number	control-token 1
----------------------	---	---------------------------	--------------------

The response to a read message comprises either control token 3, 32-bit of data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).

A.4 Accessing a register of an analogue peripheral

Peripheral registers can be accessed through the interconnect using the functions `write_periph_32(device, peripheral, ...)`, `read_periph_32(device, peripheral, ...)` ↵ `, write_periph_8(device, peripheral, ...)`, and `read_periph_8(device, peripheral ↵ , ...)`; where `device` is the name of the analogue device, and `peripheral` is the number of the peripheral. These functions implement the protocols described below.

A channel-end should be allocated to communicate with the configuration registers. The destination of the channel-end should be set to `0xnnnnpp02` where `nnnn` is the node-identifier and `pp` is the peripheral identifier.

0x12: Debug SSP	Bits	Perm	Init	Description
	31:0	DRW		Value.

B.15 DGETREG operand 1: 0x13

The resource ID of the logical core whose state is to be read.

0x13: DGETREG operand 1	Bits	Perm	Init	Description
	31:8	RO	-	Reserved
	7:0	DRW		Thread number to be read

B.16 DGETREG operand 2: 0x14

Register number to be read by DGETREG

0x14: DGETREG operand 2	Bits	Perm	Init	Description
	31:5	RO	-	Reserved
	4:0	DRW		Register number to be read

B.17 Debug interrupt type: 0x15

Register that specifies what activated the debug interrupt.

0x15: Debug interrupt type	Bits	Perm	Init	Description
	31:18	RO	-	Reserved
	17:16	DRW		Number of the hardware breakpoint/watchpoint which caused the interrupt (always 0 for =HOST= and =DCALL=). If multiple breakpoints/watchpoints trigger at once, the lowest number is taken.
	15:8	DRW		Number of thread which caused the debug interrupt (always 0 in the case of =HOST=).
	7:3	RO	-	Reserved
	2:0	DRW	0	Indicates the cause of the debug interrupt 1: Host initiated a debug interrupt through JTAG 2: Program executed a DCALL instruction 3: Instruction breakpoint 4: Data watch point 5: Resource watch point

0x07:
Security
configuration

Bits	Perm	Init	Description
31	CRO		Disables write permission on this register
30:15	RO	-	Reserved
14	CRO		Disable access to XCore's global debug
13	RO	-	Reserved
12	CRO		lock all OTP sectors
11:8	CRO		lock bit for each OTP sector
7	CRO		Enable OTP redundancy
6	RO	-	Reserved
5	CRO		Override boot mode and read boot image from OTP
4	CRO		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	CRO		Disable access to XCore's JTAG debug TAP

C.8 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the [Debug Scratch registers in the processor status](#).

0x20 .. 0x27:
Debug
scratch

Bits	Perm	Init	Description
31:0	CRW		Value.

C.9 PC of logical core 0: 0x40

Value of the PC of logical core 0.

0x40:
PC of logical
core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

C.10 PC of logical core 1: 0x41

Value of the PC of logical core 1.

C.24 SR of logical core 7: 0x67

Value of the SR of logical core 7

0x67:
SR of logical
core 7

Bits	Perm	Init	Description
31:0	CRO		Value.

D.2 System switch description: 0x01

This register specifies the number of processors and links that are connected to this switch.

0x01:
System
switch
description

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	RO		Number of SLinks on the SSwitch.
15:8	RO		Number of processors on the SSwitch.
7:0	RO		Number of processors on the device.

D.3 Switch configuration: 0x04

This register enables the setting of two security modes (that disable updates to the PLL or any other registers) and the header-mode.

0x04:
Switch
configuration

Bits	Perm	Init	Description
31	RW	0	0 = SSCTL registers have write access. 1 = SSCTL registers can not be written to.
30:9	RO	-	Reserved
8	RW	0	0 = PLL_CTL_REG has write access. 1 = PLL_CTL_REG can not be written to.
7:1	RO	-	Reserved
0	RW	0	0 = 2-byte headers, 1 = 1-byte headers (reset as 0).

D.4 Switch node identifier: 0x05

This register contains the node identifier.

0x05:
Switch node
identifier

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	The unique ID of this node.

D.5 PLL settings: 0x06

An on-chip PLL multiplies the input clock up to a higher frequency clock, used to clock the I/O, processor, and switch, see [Oscillator](#). Note: a write to this register will cause the tile to be reset.

0x0D:
Directions
8-15

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose dimension is F.
27:24	RW	0	The direction for packets whose dimension is E.
23:20	RW	0	The direction for packets whose dimension is D.
19:16	RW	0	The direction for packets whose dimension is C.
15:12	RW	0	The direction for packets whose dimension is B.
11:8	RW	0	The direction for packets whose dimension is A.
7:4	RW	0	The direction for packets whose dimension is 9.
3:0	RW	0	The direction for packets whose dimension is 8.

D.12 DEBUG_N configuration, tile 0: 0x10

Configures the behavior of the DEBUG_N pin.

0x10:
DEBUG_N con-
figuration,
tile 0

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Set 1 to enable GlobalDebug to generate debug request to XCore.
0	RW	0	Set 1 to enable inDebug bit to drive GlobalDebug.

D.13 DEBUG_N configuration, tile 1: 0x11

Configures the behavior of the DEBUG_N pin.

0x11:
DEBUG_N con-
figuration,
tile 1

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Set 1 to enable GlobalDebug to generate debug request to XCore.
0	RW	0	Set 1 to enable inDebug bit to drive GlobalDebug.

D.14 Debug source: 0x1F

Contains the source of the most recent debug event.

0x1F:
Debug source

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4	RW		If set, external pin, is the source of last GlobalDebug event.
3:2	RO	-	Reserved
1	RW		If set, XCore1 is the source of last GlobalDebug event.
0	RW		If set, XCore0 is the source of last GlobalDebug event.

D.15 Link status, direction, and network: 0x20 .. 0x28

These registers contain status information for low level debugging (read-only), the network number that each link belongs to, and the direction that each link is part of. The registers control links 0..7.

0x20 .. 0x28:
Link status,
direction, and
network

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		Identify the SRC_TARGET type 0 - SLink, 1 - PLink, 2 - SSCTL, 3 - Undefine.
23:16	RO		When the link is in use, this is the destination link number to which all packets are sent.
15:12	RO	-	Reserved
11:8	RW	0	The direction that this link operates in.
7:6	RO	-	Reserved
5:4	RW	0	Determines the network to which this link belongs, reset as 0.
3	RO	-	Reserved
2	RO		1 when the current packet is considered junk and will be thrown away.
1	RO		1 when the dest side of the link is in use.
0	RO		1 when the source side of the link is in use.

D.16 PLink status and network: 0x40 .. 0x47

These registers contain status information and the network number that each processor-link belongs to.

0x40 .. 0x47:
PLink status
and network

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		Identify the SRC_TARGET type 0 - SLink, 1 - PLink, 2 - SSCTL, 3 - Undefine.
23:16	RO		When the link is in use, this is the destination link number to which all packets are sent.
15:6	RO	-	Reserved
5:4	RW	0	Determines the network to which this link belongs, reset as 0.
3	RO	-	Reserved
2	RO		1 when the current packet is considered junk and will be thrown away.
1	RO		1 when the dest side of the link is in use.
0	RO		1 when the source side of the link is in use.

D.17 Link configuration and initialization: 0x80 .. 0x88

These registers contain configuration and debugging information specific to external links. The link speed and width can be set, the link can be initialized, and the link status can be monitored. The registers control links 0..7.

0x80 .. 0x88:
Link
configuration
and
initialization

Bits	Perm	Init	Description
31	RW		Write to this bit with '1' will enable the XLink, writing '0' will disable it. This bit controls the muxing of ports with overlapping xlinks.
30	RW	0	0: operate in 2 wire mode; 1: operate in 5 wire mode
29:28	RO	-	Reserved
27	RO		Rx buffer overflow or illegal token encoding received.
26	RO	0	This end of the xlink has issued credit to allow the remote end to transmit
25	RO	0	This end of the xlink has credit to allow it to transmit.
24	WO		Clear this end of the xlink's credit and issue a HELLO token.
23	WO		Reset the receiver. The next symbol that is detected will be the first symbol in a token.
22	RO	-	Reserved
21:11	RW	0	Specify min. number of idle system clocks between two continuous symbols within a transmit token -1.
10:0	RW	0	Specify min. number of idle system clocks between two continuous transmit tokens -1.

D.18 Static link configuration: 0xA0 .. 0xA7

These registers are used for static (ie, non-routed) links. When a link is made static, all traffic is forwarded to the designated channel end and no routing is attempted. The registers control links C, D, A, B, G, H, E, and F in that order.

0xA0 .. 0xA7:
Static link
configuration

Bits	Perm	Init	Description
31	RW	0	Enable static forwarding.
30:9	RO	-	Reserved
8	RW	0	The destination processor on this node that packets received in static mode are forwarded to.
7:5	RO	-	Reserved
4:0	RW	0	The destination channel end on this node that packets received in static mode are forwarded to.

0x04:
UIFM IFM
control

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7	RW	0	Set to 1 to enable XEVACKMODE mode.
6	RW	0	Set to 1 to enable SOFISTOKEN mode.
5	RW	0	Set to 1 to enable UIFM power signalling mode.
4	RW	0	Set to 1 to enable IF timing mode.
3	RO	-	Reserved
2	RW	0	Set to 1 to enable UIFM linestate decoder.
1	RW	0	Set to 1 to enable UIFM CHECKTOKENS mode.
0	RW	0	Set to 1 to enable UIFM DOTOKENS mode.

F.3 UIFM Device Address: 0x08

The device address whose packets should be received. 0 until enumeration, it should be set to the assigned value after enumeration.

0x08:
UIFM Device
Address

Bits	Perm	Init	Description
31:7	RO	-	Reserved
6:0	RW	0	The enumerated USB device address must be stored here. Only packets to this address are passed on.

F.4 UIFM functional control: 0x0C

0x0C:
UIFM
functional
control

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4:2	RW	1	Set to 0 to disable UIFM to UTMI+ OPMODE mode.
1	RW	1	Set to 1 to switch UIFM to UTMI+ TERMSELECT mode.
0	RW	1	Set to 1 to switch UIFM to UTMI+ XCVRSELECT mode.

F.5 UIFM on-the-go control: 0x10

This register is used to negotiate an on-the-go connection.

	Bits	Perm	Init	Description
0x2C: UIFM PID	31:4	RO	-	Reserved
	3:0	RO	0	Value of the last received PID.

F.13 UIFM Endpoint: 0x30

The last endpoint seen

	Bits	Perm	Init	Description
0x30: UIFM Endpoint	31:5	RO	-	Reserved
	4	RO	0	1 if endpoint contains a valid value.
	3:0	RO	0	A copy of the last received endpoint.

F.14 UIFM Endpoint match: 0x34

This register can be used to mark UIFM endpoints as special.

	Bits	Perm	Init	Description
0x34: UIFM Endpoint match	31:16	RO	-	Reserved
	15:0	RW	0	This register contains a bit for each endpoint. If its bit is set, the endpoint will be supplied on the RX port when ORed with 0x10.

F.15 OTG Flags mask: 0x38

	Bits	Perm	Init	Description
0x38: OTG Flags mask	31:0	RW	0	Data

F.16 UIFM power signalling: 0x3C

	Bits	Perm	Init	Description
0x3C: UIFM power signalling	31:9	RO	-	Reserved
	8	RW	0	Valid
	7:0	RW	0	Data

H Schematics Design Check List

- ✓ This section is a checklist for use by schematics designers using the XU216-512-FB236. Each of the following sections contains items to check for each design.

H.1 Power supplies

- ☐ VDDIO and OTP_VCC supply is within specification before the VDD (core) supply is turned on. Specifically, the VDDIO and OTP_VCC supply is within specification before VDD (core) reaches 0.4V (Section 12).
- ☐ The VDD (core) supply ramps monotonically (rises constantly) from 0V to its final value (0.95V - 1.05V) within 10ms (Section 12).
- ☐ The VDD (core) supply is capable of supplying 700 mA (Section 12 and Figure 22).
- ☐ PLL_AVDD is filtered with a low pass filter, for example an RC filter, see Section 12

H.2 Power supply decoupling

- ☐ The design has multiple decoupling capacitors per supply, for example at least four 0402 or 0603 size surface mount capacitors of 100nF in value, per supply (Section 12).
- ☐ A bulk decoupling capacitor of at least 10uF is placed on each supply (Section 12).

H.3 Power on reset

- ☐ The RST_N and TRST_N pins are asserted (low) during or after power up. The device is not used until these resets have taken place.

H.4 Clock

- ☐ The CLK input pin is supplied with a clock with monotonic rising edges and low jitter.
- ☐ Pins MODE0 and MODE1 are set to the correct value for the chosen oscillator frequency. The MODE settings are shown in the Oscillator section, Section 7. If you have a choice between two values, choose the value with the highest multiplier ratio since that will boot faster.